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Product group:

Heatsinks and active heatsinks for processors > Heatsinks for LEDs

Heatsinks for LEDs / **ICK LED R 28 x 15**   



Ø 28 x 15 mm, for IC design LED

Parameters of article ICK LED R 28 x 15

R_{th} [K/W]	 15.24
dissipation loss [W]	 7.8
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
Ø [mm]	 27.95
height [mm]	15.24
plate thickness [mm]	3.5
surface treatment	black anodised

Technical Drawing

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 D 28**

Thermally conductive foil both sides adhesive / **WLFT 405 D 28**

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